

**SCOPE: CMOS, 12-BIT MONOLITHIC, MULTIPLYING D/A CONVERTER**

<u>Device Type</u>	<u>Generic Number</u>
01	MX7541AS(x)/883B
02	MX7541AT(x)/883B

**Case Outline(s).** The case outlines shall be designated in Mil-Std-1835 and as follows:

<u>Outline Letter</u>	<u>Mil-Std-1835</u>	<u>Case Outline</u>	<u>Package Code</u>
Q	GDIP1-T18 or CDIP2-T18	18 LEAD CERDIP	J18
E	CQCC1-N20	20 LCC	L20

**Absolute Maximum Ratings:**

$V_{DD}$ to GND .....	+ 17V
$V_{RFB}$ to GND .....	$\pm 25V$
$V_{REF}$ to GND .....	$\pm 25V$
Digital Input Voltage Range .....	-0.3V to $V_{DD}$
$V_{OUT1}$ , $V_{OUT2}$ , to GND .....	-0.3V to $V_{DD}$

Lead Temperature (soldering, 10 seconds) .....	+300°C
Storage Temperature .....	-65°C to +150°C

Continuous Power Dissipation .....	$T_A = +70^\circ C$
18 pin CERDIP (derate 10.5mW/°C above +70°C) .....	842mW
20 pin LCC (derate 9.1mW/°C above +70°C) .....	727mW
Junction Temperature $T_J$ .....	+150°C
Thermal Resistance, Junction to Case, $\theta_{JC}$	
18 pin CERDIP .....	45°C/W
20 pin LCC .....	20°C/W
Thermal Resistance, Junction to Ambient, $\theta_{JA}$ :	
18 pin CERDIP .....	95°C/W
20 pin LCC .....	110°C/W

**Recommended Operating Conditions**

Ambient Operating Range ( $T_A$ ) .....	-55°C to +125°C
Logic Supply Voltage (VLOGIC) .....	+4.5D to +5.5V
Positive Supply Voltage .....	+15V
Negative Supply Voltage .....	-15V

Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**TABLE 1. ELECTRICAL TESTS:**

TEST	Symbol	CONDITIONS		Limits Min	Limits Max	Units
		-55 °C ≤ T <sub>A</sub> ≤ +125 °C <u>1</u> /	Unless otherwise specified			
<b>ACCURACY</b>						
Resolution NOTE 2	RES			All	12	Bits
Relative Accuracy	RA		1,2,3	01 02		±1.0 ±0.5 LSB
Differential Nonlinearity	DNL	All grades guaranteed monotonic over temperature	1,2,3	01 02		±1.0 ±0.5 LSB
Gain Error NOTE 3	AE		1 2,3	01		±6 ±8 LSB
			1 2,3	02		±3 ±5
Gain Temperature Coefficient NOTE 2	TC <sub>AE</sub>			All		±5 ppm/°C
Power Supply Rejection	PSRR	ΔV <sub>DD</sub> =±5%	1 2,3	All		±0.01 ±0.02 %/%
Output Leakage Current	I <sub>OUT1</sub>	Digital inputs = 0V	1 2,3	All		±5.0 ±200 nA
	I <sub>OUT2</sub>	Digital inputs = V <sub>DD</sub>	1 2,3	All		±5.0 ±200 nA
Output Current Settling Time NOTE 2		To ±0.5%LSB. OUT 1 load is 100Ω   13pF, digital inputs =V <sub>IH</sub> to V <sub>IL</sub> or V <sub>IL</sub> to V <sub>IH</sub>	4	All		0.6 μs
Feedthrough Error NOTE 2, NOTE 4	FTE	VREF=20Vp-p at 10kHz sine wave	4	All		1.0 mVp-p
Input Resistance	R <sub>IN</sub>		1,2,3	All	7	18 kΩ
Digital Input High Voltage	V <sub>IH</sub>		1,2,3	All	2.4	V
Digital Input Low Voltage	V <sub>IL</sub>		1,2,3	All		0.8 V
Digital Input Leakage Current	I <sub>IN</sub>	V <sub>IN</sub> =0V or V <sub>DD</sub>	1 2,3	All		±1.0 μA
Supply Current	I <sub>DD</sub>	All digital inputs V <sub>IL</sub> or V <sub>IH</sub>	1,2,3	All		2.0 mA
		All digital inputs 0V or V <sub>DD</sub>	1 2,3	All		100 500 mA
Digital Input Capacitance NOTE 2	C <sub>IN</sub>		4	All		8 pF
Output Capacitance NOTE 2	C <sub>OUT1</sub>	Digital inputs at V <sub>IH</sub> Digital inputs at V <sub>IL</sub>	4	All		200 70 pF
	C <sub>OUT2</sub>	Digital inputs at V <sub>IH</sub> Digital inputs at V <sub>IL</sub>				70 200 pF

NOTE 1:  $V_{DD}=+15V$ ,  $V_{OUT1}=V_{OUT2}=0V$ ;  $V_{REF}=+10V$ , unless otherwise specified.

NOTE 2: Characteristics supplied for use as a typical design limit, but not production tested.

NOTE 3: Measured using internal feedback resistor and includes effect of leakage current and gain TC.

NOTE 4: Feedthrough error can be reduced by connecting the metal lid on the package to ground.

#### ORDERING INFORMATION:

	Package	Pkg. Code	MAXIM PART #	SMD NUMBER
01	18 pin CERDIP	J18	MX7541ASQ/883B	5962-8948101VA
01	20 pin LCC	L20	MX7541ASE/883B	5962-89481012C
02	18 pin CERDIP	J18	MX7541ATQ/883B	5962-8948102VA
02	20 pin LCC	L20	MX7541ATE/883B	5962-89481022C

#### TERMINAL CONNECTIONS:

	J18	L20
Pin		
1	OUT1	NC
2	OUT2	OUT1
3	GND	OUT2
4	D1(MSB)	GND
5	D2	D1(MSB)
6	D3	D2
7	D4	D3
8	D5	D4
9	D6	D5
10	D7	D6
11	D8	NC
12	D9	D7
13	D10	D8
14	D11	D9
15	D12(LSB)	D10
16	$V_{DD}$	D11
17	VREF	D12(LSB)
18	$R_{FB}$	$V_{DD}$
19		VREF
20		$R_{FB}$

**QUALITY ASSURANCE**

Sampling and inspection procedures shall be in accordance with MIL-Prf-38535, Appendix A as specified in Mil-Std-883.

Screening shall be in accordance with Method 5004 of Mil-Std-883. Burn-in test Method 1015:

1. Test Condition, A, B, C, or D.
2. TA = +125°C minimum.
3. Interim and final electrical test requirements shall be specified in Table 2.

Quality conformance inspection shall be in accordance with Method 5005 of Mil-Std-883, including Groups A, B, C, and D inspection.

Group A inspection:

1. Tests as specified in Table 2.
2. Selected subgroups in Table 1, Method 5005 of Mil-Std-883 shall be omitted.

Group C and D inspections:

- a. End-point electrical parameters shall be specified in Table 1.
- b. Steady-state life test, Method 1005 of Mil-Std-883:
  1. Test condition A, B, C, D.
  2. TA = +125°C, minimum.
  3. Test duration, 1000 hours, except as permitted by Method 1005 of Mil-Std-883.

**TABLE 2. ELECTRICAL TEST REQUIREMENTS**

Mil-Std-883 Test Requirements	Subgroups per Method 5005, Table 1
Interim Electric Parameters Method 5004	1
Final Electrical Parameters Method 5005	1*, 2, 3
Group A Test Requirements Method 5005	1, 2, 3, 4**
Group C and D End-Point Electrical Parameters Method 5005	1

\* PDA applies to Subgroup 1 only.

\*\* Subgroup 4 shall be tested at initial qualification and upon redesign. Sample size will be 116 units.